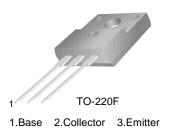
# FAIRCHILD

SEMICONDUCTOR®

# **FJPF5321**

## High Voltage and High Reliability

- High speed Switching
- Wide Safe Operating Area



# NPN Triple Diffused Planar Silicon Transistor

Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
/ <sub>СВО</sub>	Collector-Base Voltage	800	V
/ <sub>CEO</sub>	Collector-Emitter Voltage	500	V
/ <sub>EBO</sub>	Emitter-Base Voltage	7	V
С	Collector Current (DC)	5	А
CP	*Collector Current (Pulse)	10	А
В	Base Current (DC)	2	А
BP	*Base Current (Pulse)	4	А
°c	Power Dissipation(T <sub>C</sub> =25°C)	40	W
J	Junction Temperature	150	°C
STG	Storage Temperature	- 55 ~ 150	°C

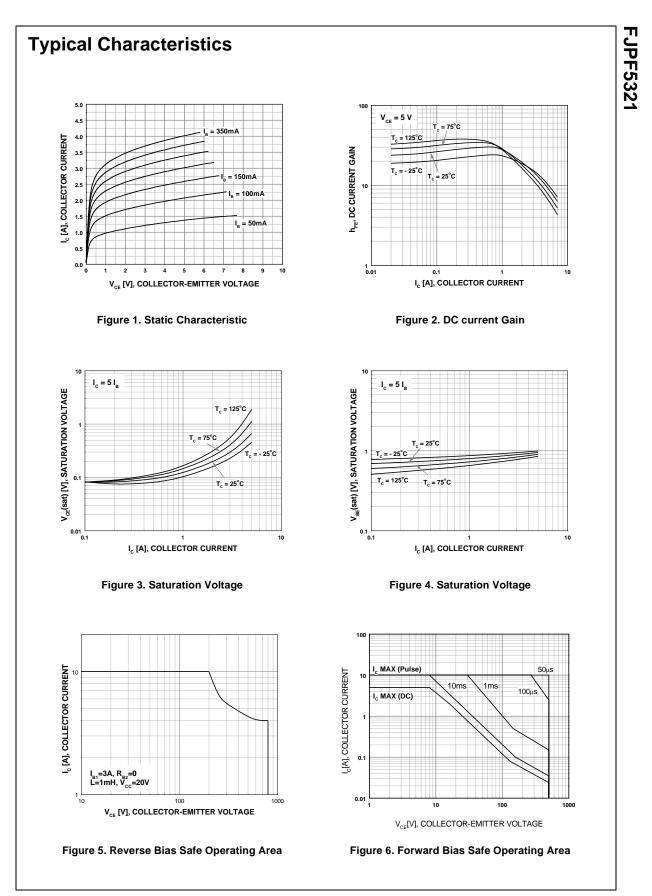
Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = 1mA, I <sub>E</sub> = 0	800	-	-	V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 5mA, I <sub>B</sub> = 0	500	-	-	V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_{\rm C} = 1$ mA, $I_{\rm C} = 0$	7	-	-	V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 800 V, I_E = 0$	-	-	100	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 7V, I_{C} = 0$	-	-	10	μΑ
h <sub>FE1</sub>	DC Current Gain	V <sub>CE</sub> = 5V, I <sub>C</sub> = 0.6A	15	-	40	
h <sub>FE2</sub>		$V_{CE} = 5V, I_{C} = 3A$	8	-	-	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 3A, I <sub>B</sub> = 0.6A	-	-	1.0	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = 3A, I <sub>B</sub> = 0.6A	-	-	1.5	V
f <sub>T</sub>	Current Gain bandwidth Product	$V_{CE} = 10V, I_{C} = 0.6A$	-	14	-	MHz
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 1MHz$	-	65	100	pF
C <sub>ib</sub>	Input Capacitance	$V_{EB} = 7V, I_{C} = 0, f = 1MHz$	-	1400	2000	pF
t <sub>ON</sub>	Turn On Time	V <sub>CC</sub> = 125V, I <sub>C</sub> = 1A	-	-	0.5	μs
t <sub>STG</sub>	Storage Time	Ι <sub>B1</sub> = -Ι <sub>B2</sub> = 0.2Α		-	6.5	μs
t <sub>F</sub>	Fall Time	$R_L = 125\Omega$	-	-	0.3	μs
t <sub>ON</sub>	Turn On Time	$V_{CC} = 250V, I_{C} = 4A$	-	-	0.5	μs
t <sub>STG</sub>	Storage Time	I <sub>B1</sub> = 0.8A, I <sub>B2</sub> = -1.6A	-	-	3.0	μs
t <sub>F</sub>	Fall Time	$R_L = 62.5\Omega$	-	-	0.3	μs

FJPF5321

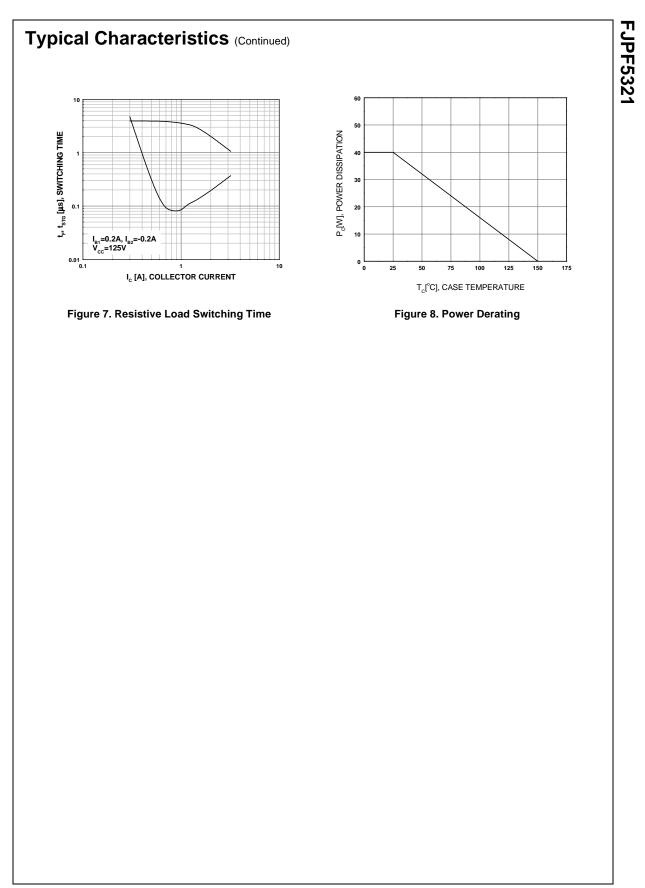
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Symbol		Characteristics	Rating	Unit
ic	Thermal Resistance	Junction to Case	3.1	°C/W
a		Junction to Ambient	62.5	Ţ



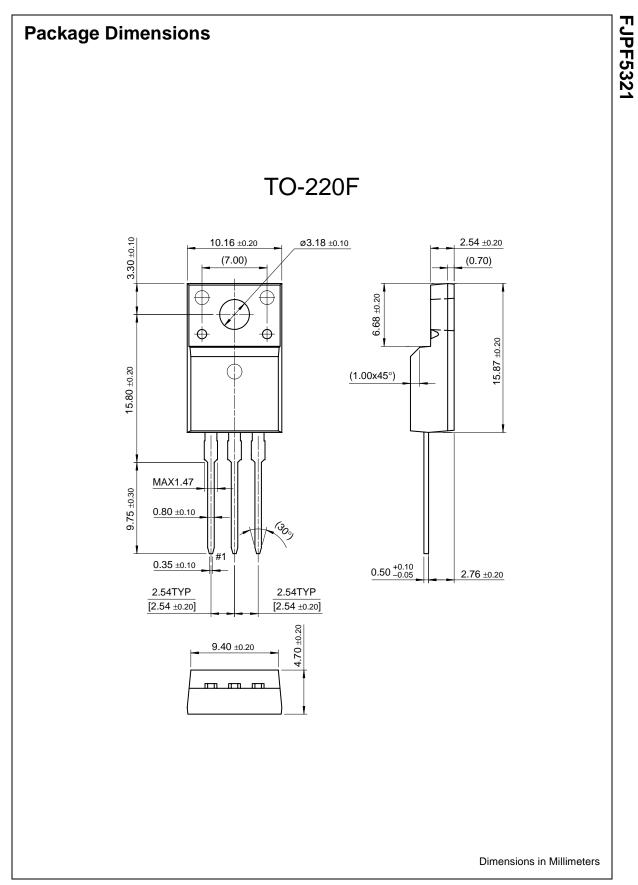
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Programmable A	ctive Droop™	POP™	SuperFET™	

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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